## **PRODUCT / PROCESS CHANGE NOTIFICATION**

1. PCN basic data		
1.1 Company	STMicroelectronics International N.V	
1.2 PCN No.	ADG/24/14592	
1.3 Title of PCN	TO-220FP line transfer from Shenzhen to TFME Tongke (China)	
1.4 Product Category	IGBT's	
1.5 Issue date	2024-03-12	

2. PCN Team	
2.1 Contact supplier	
2.1.1 Name	KRAUSE INA
2.1.2 Phone	+49 89460062370
2.1.3 Email	ina.krause@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Angelo RAO
2.1.2 Marketing Manager	Natale Sandro D'ANGELO
2.1.3 Quality Manager	Vincenzo MILITANO

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	

4. Description of change		
	Old New	
4.1 Description	TO-220FP products are manufactured in Shenzhen (China)	TO-220FP products are manufactured in TFME Tongke (China)
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	processability	

5. Reason / motivation for change	
5.1 Motivation TO-220FP Shenzhen line closure and equipment transfer to TFME Tongke	
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change		
6.1 Description	6.1 Description By dedicated FG codes	

7. Timing / schedule		
7.1 Date of qualification results 2024-02-19		
7.2 Intended start of delivery	2024-05-19	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description 14592 RERPTD24010_1.0_TO220FP package Transfer from STS to Tongke subcon for IGBT at Bipolar transistor products.pdf			ocon for IGBT and
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2024-03-12

## 9. Attachments (additional documentations)

14592 Public product.pdf 14592 14592.pdf 14592 RERPTD24010\_1.0\_TO220FP package Transfer from STS to Tongke subcon for IGBT and Bipolar transistor products.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	BDW94CFP	
	BUL1102EFP	
	STGF15H60DF	
	STGF20H60DF	
	STGF20M65DF2	
	STGF30M65DF2	
	STGF5H60DF	

## IMPORTANT NOTICE - PLEASE READ CAREFULLY

Subject to any contractual arrangement in force with you or to any industry standard implemented by us, STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2022 STMicroelectronics - All rights reserved